

DATA SHEET

PSMN005-55B; PSMN005-55P

N-channel logic level

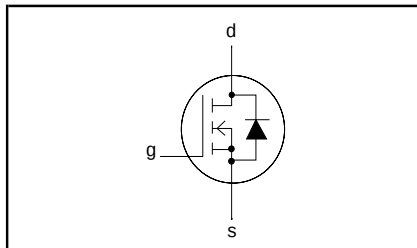
TrenchMOS^(TM) transistor

Product specification

October 1999

SiliconMAX**N-channel logic level TrenchMOS^(TM) transistor****PSMN005-55B;
PSMN005-55P****FEATURES**

- 'Trench' technology
- Very low on-state resistance
- Fast switching
- Low thermal resistance

SYMBOL**QUICK REFERENCE DATA**

$$V_{DSS} = 55 \text{ V}$$

$$I_D = 75 \text{ A}$$

$$R_{DS(ON)} \leq 5.8 \text{ m}\Omega \text{ (} V_{GS} = 10 \text{ V)}$$

$$R_{DS(ON)} \leq 6.3 \text{ m}\Omega \text{ (} V_{GS} = 5 \text{ V)}$$

GENERAL DESCRIPTION

SiliconMAX products use the latest Philips Trench technology to achieve the lowest possible on-state resistance in each package at each voltage rating.

Applications:-

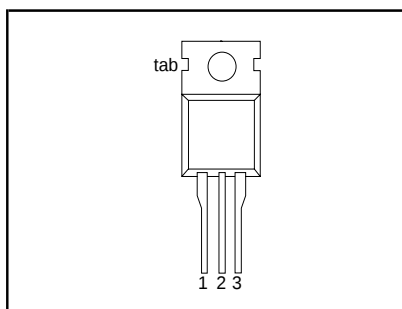
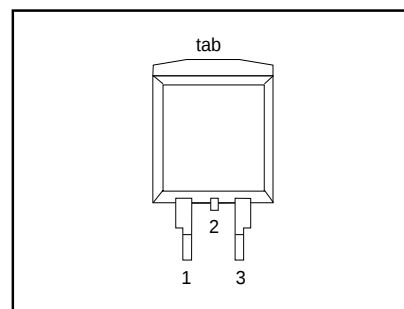
- d.c. to d.c. converters
- switched mode power supplies

The PSMN005-55P is supplied in the SOT78 (TO220AB) conventional leaded package.

The PSMN005-55B is supplied in the SOT404 surface mounting package.

PINNING

PIN	DESCRIPTION
1	gate
2	drain ¹
3	source
tab	drain

SOT78 (TO220AB)**SOT404 (D²PAK)****LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DSS}	Drain-source voltage	$T_j = 25^\circ\text{C}$ to 175°C	-	55	V
V_{DGR}	Drain-gate voltage	$T_j = 25^\circ\text{C}$ to 175°C ; $R_{GS} = 20 \text{ k}\Omega$	-	55	V
V_{GS}	Continuous gate-source voltage		-	± 15	V
V_{GSM}	Peak pulsed gate-source voltage	$T_j \leq 150^\circ\text{C}$	-	± 20	V
I_D	Continuous drain current	$T_{mb} = 25^\circ\text{C}$; $V_{GS} = 5 \text{ V}$	-	75 ²	A
		$T_{mb} = 100^\circ\text{C}$; $V_{GS} = 5 \text{ V}$	-	75 ²	A
I_{DM}	Pulsed drain current	$T_{mb} = 25^\circ\text{C}$	-	240	A
P_D	Total power dissipation	$T_{mb} = 25^\circ\text{C}$	-	230	W
T_j, T_{stg}	Operating junction and storage temperature		- 55	175	$^\circ\text{C}$

¹ It is not possible to make connection to pin:2 of the SOT404 package

² maximum current limited by package

SiliconMAXN-channel logic level TrenchMOS^(TM) transistorPSMN005-55B;
PSMN005-55P**THERMAL RESISTANCES**

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$R_{th\ j-mb}$	Thermal resistance junction to mounting base		-	0.65	K/W
$R_{th\ j-a}$	Thermal resistance junction to ambient	SOT78 package, in free air SOT404 package, pcb mounted, minimum footprint	60 50	- -	K/W K/W

AVALANCHE ENERGY LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
E_{AS}	Non-repetitive avalanche energy	Unclamped inductive load, $I_{AS} = 75\text{ A}$; $t_p = 100\text{ }\mu\text{s}$; T_j prior to avalanche = 25°C ; $V_{DD} \leq 15\text{ V}$; $R_{GS} = 50\text{ }\Omega$; $V_{GS} = 5\text{ V}$	-	268	mJ
I_{AS}	Non-repetitive avalanche current		-	75	A

ELECTRICAL CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0\text{ V}$; $I_D = 0.25\text{ mA}$; $T_j = -55^\circ\text{C}$	55 50	- -	- -	V V
$V_{GS(TO)}$	Gate threshold voltage	$V_{DS} = V_{GS}$; $I_D = 1\text{ mA}$; $T_j = 175^\circ\text{C}$ $T_j = -55^\circ\text{C}$	1.0 0.5 -	1.5 - -	2.0 - 2.3	V V V
$R_{DS(ON)}$	Drain-source on-state resistance	$V_{GS} = 10\text{ V}$; $I_D = 25\text{ A}$ $V_{GS} = 5\text{ V}$; $I_D = 25\text{ A}$ $V_{GS} = 4.5\text{ V}$; $I_D = 25\text{ A}$ $V_{GS} = 5\text{ V}$; $I_D = 25\text{ A}$; $T_j = 175^\circ\text{C}$	- - - -	4.8 5.3 - -	5.8 6.3 6.7 13.2	m Ω m Ω m Ω m Ω
I_{GSS}	Gate source leakage current	$V_{GS} = \pm 10\text{ V}$; $V_{DS} = 0\text{ V}$	-	2	100	nA
I_{DSS}	Zero gate voltage drain current	$V_{DS} = 55\text{ V}$; $V_{GS} = 0\text{ V}$; $T_j = 175^\circ\text{C}$	-	0.05	10 500	μA μA
$Q_{g(tot)}$	Total gate charge	$I_D = 75\text{ A}$; $V_{DD} = 44\text{ V}$; $V_{GS} = 5\text{ V}$	-	103	-	nC
Q_{gs}	Gate-source charge		-	15	-	nC
Q_{gd}	Gate-drain (Miller) charge		-	52	-	nC
$t_{d\ on}$	Turn-on delay time	$V_{DD} = 30\text{ V}$; $R_D = 1.2\text{ }\Omega$; $V_{GS} = 5\text{ V}$; $R_G = 10\text{ }\Omega$	-	45	-	ns
t_r	Turn-on rise time		-	180	-	ns
$t_{d\ off}$	Turn-off delay time	Resistive load	-	420	-	ns
t_f	Turn-off fall time		-	235	-	ns
L_d	Internal drain inductance	Measured from tab to centre of die	-	3.5	-	nH
L_d	Internal drain inductance	Measured from drain lead to centre of die (SOT78 package only)	-	4.5	-	nH
L_s	Internal source inductance	Measured from source lead to source bond pad	-	7.5	-	nH
C_{iss}	Input capacitance	$V_{GS} = 0\text{ V}$; $V_{DS} = 25\text{ V}$; $f = 1\text{ MHz}$	-	6500	-	pF
C_{oss}	Output capacitance		-	1500	-	pF
C_{rss}	Feedback capacitance		-	700	-	pF



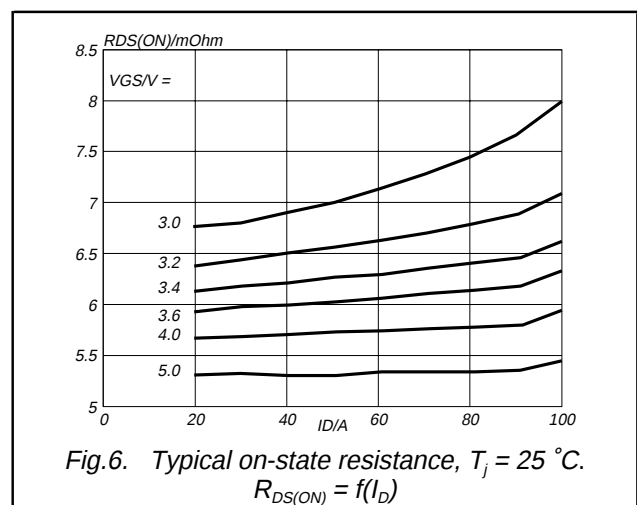
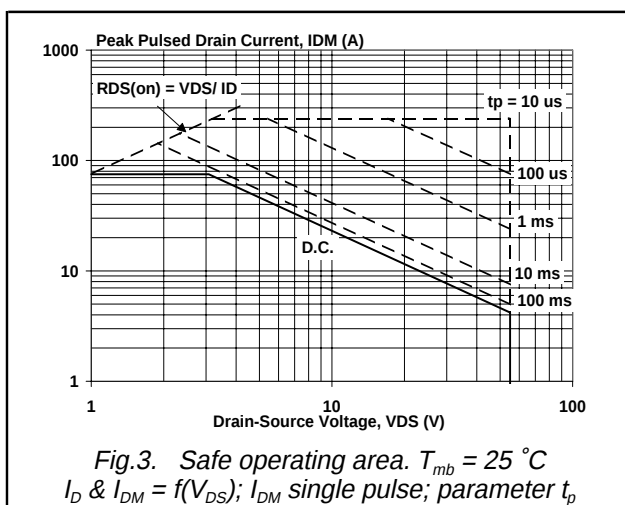
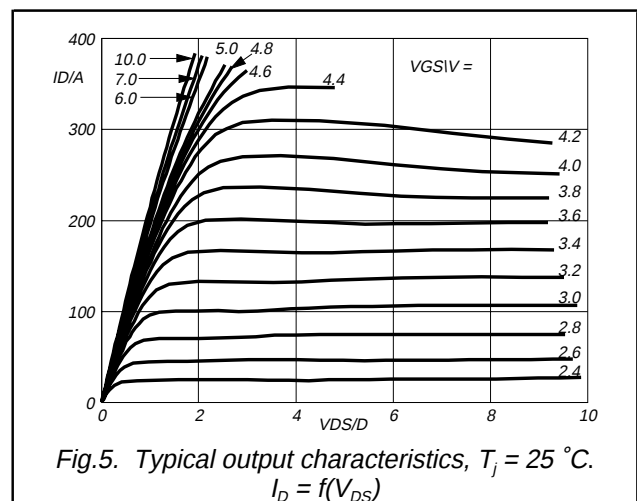
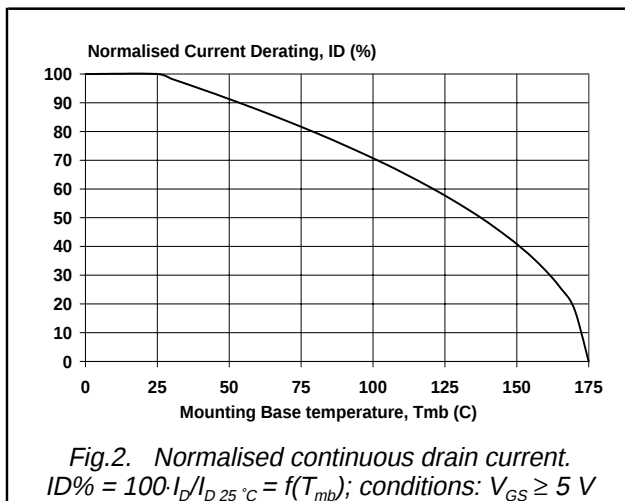
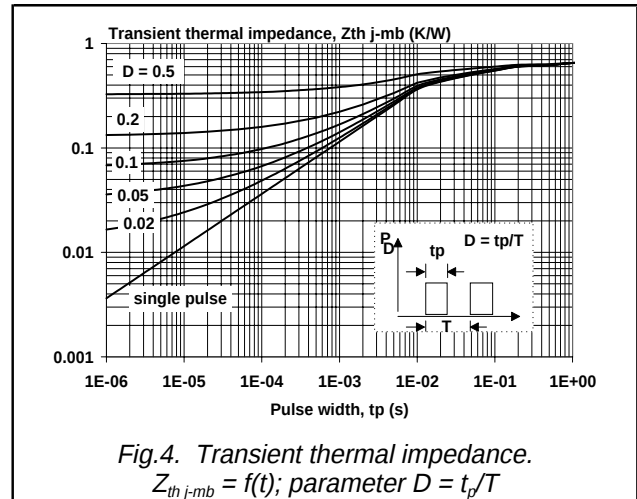
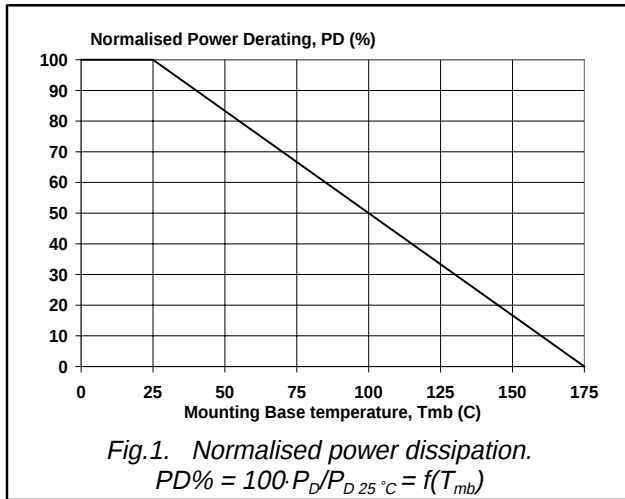
N-channel logic level TrenchMOS^(TM) transistor

PSMN005-55B;
PSMN005-55P

REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_S	Continuous source current (body diode)		-	-	75	A
I_{SM}	Pulsed source current (body diode)		-	-	240	A
V_{SD}	Diode forward voltage	$I_F = 25\text{ A}; V_{GS} = 0\text{ V}$	-	0.85	1.2	V
		$I_F = 75\text{ A}; V_{GS} = 0\text{ V}$	-	1.1	-	V
t_{rr}	Reverse recovery time	$I_F = 20\text{ A}; -dI_F/dt = 100\text{ A}/\mu\text{s};$	-	80	-	ns
Q_{rr}	Reverse recovery charge	$V_{GS} = 0\text{ V}; V_R = 30\text{ V}$	-	0.2	-	μC

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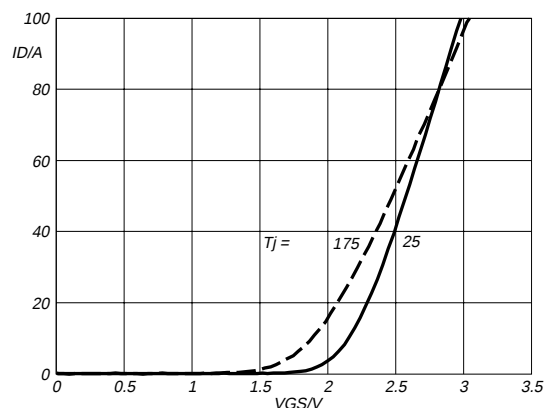
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Fig. 7. Typical transfer characteristics.
 $I_D = f(V_{GS})$

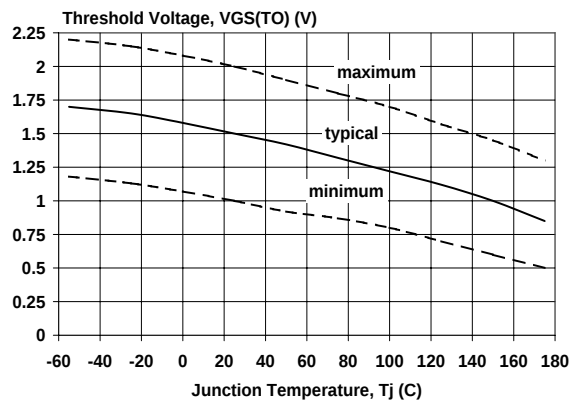


Fig. 10. Gate threshold voltage.
 $V_{GS(T0)} = f(T_j)$; conditions: $I_D = 1 \text{ mA}$; $V_{DS} = V_{GS}$

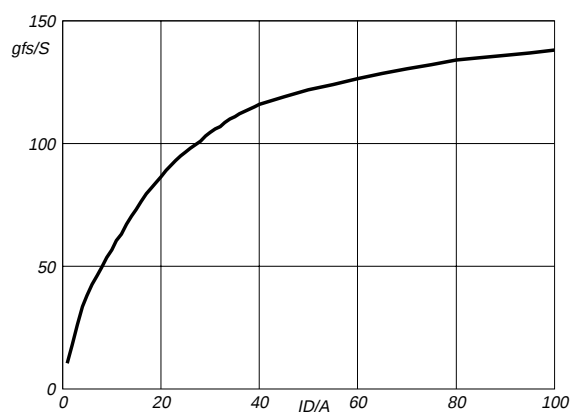


Fig. 8. Typical transconductance, $T_j = 25^\circ\text{C}$.
 $g_{fs} = f(I_D)$

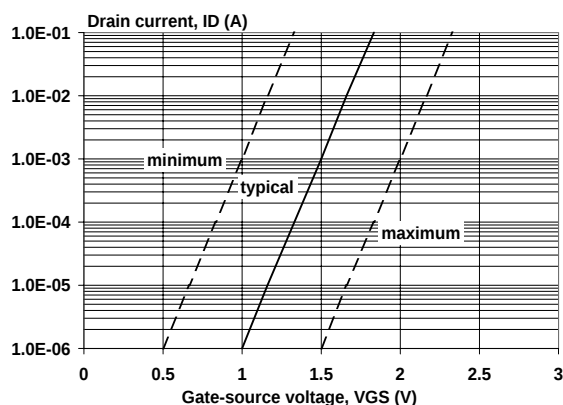


Fig. 11. Sub-threshold drain current.
 $I_D = f(V_{GS})$; conditions: $T_j = 25^\circ\text{C}$; $V_{DS} = V_{GS}$

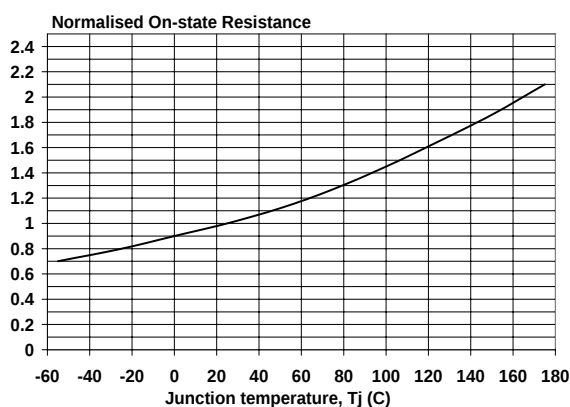


Fig. 9. Normalised drain-source on-state resistance.
 $R_{DS(ON)}/R_{DS(ON)25^\circ\text{C}} = f(T_j)$

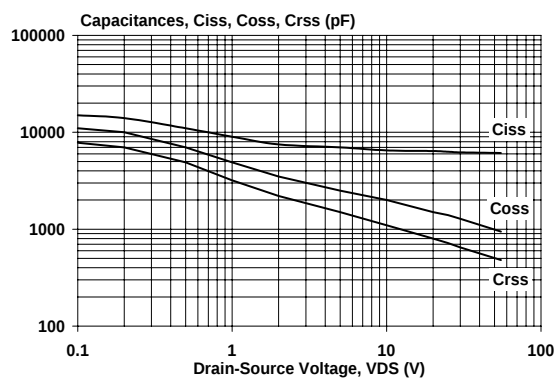


Fig. 12. Typical capacitances, C_{iss} , C_{oss} , C_{rss} .
 $C = f(V_{DS})$; conditions: $V_{GS} = 0 \text{ V}$; $f = 1 \text{ MHz}$

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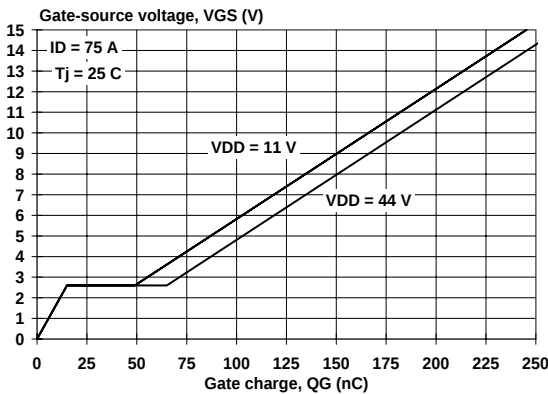


Fig.13. Typical turn-on gate-charge characteristics.
 $V_{GS} = f(Q_G)$

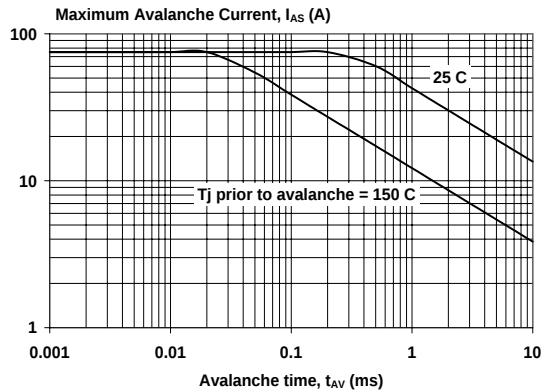


Fig.15. Maximum permissible non-repetitive
avalanche current (I_{AS}) versus avalanche time (t_{AV});
unclamped inductive load

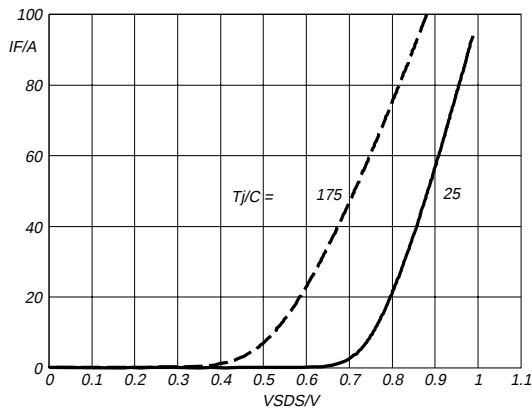


Fig.14. Typical reverse diode current.
 $I_F = f(V_{SDS})$; conditions: $V_{GS} = 0\text{ V}$; parameter T_j

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MECHANICAL DATA

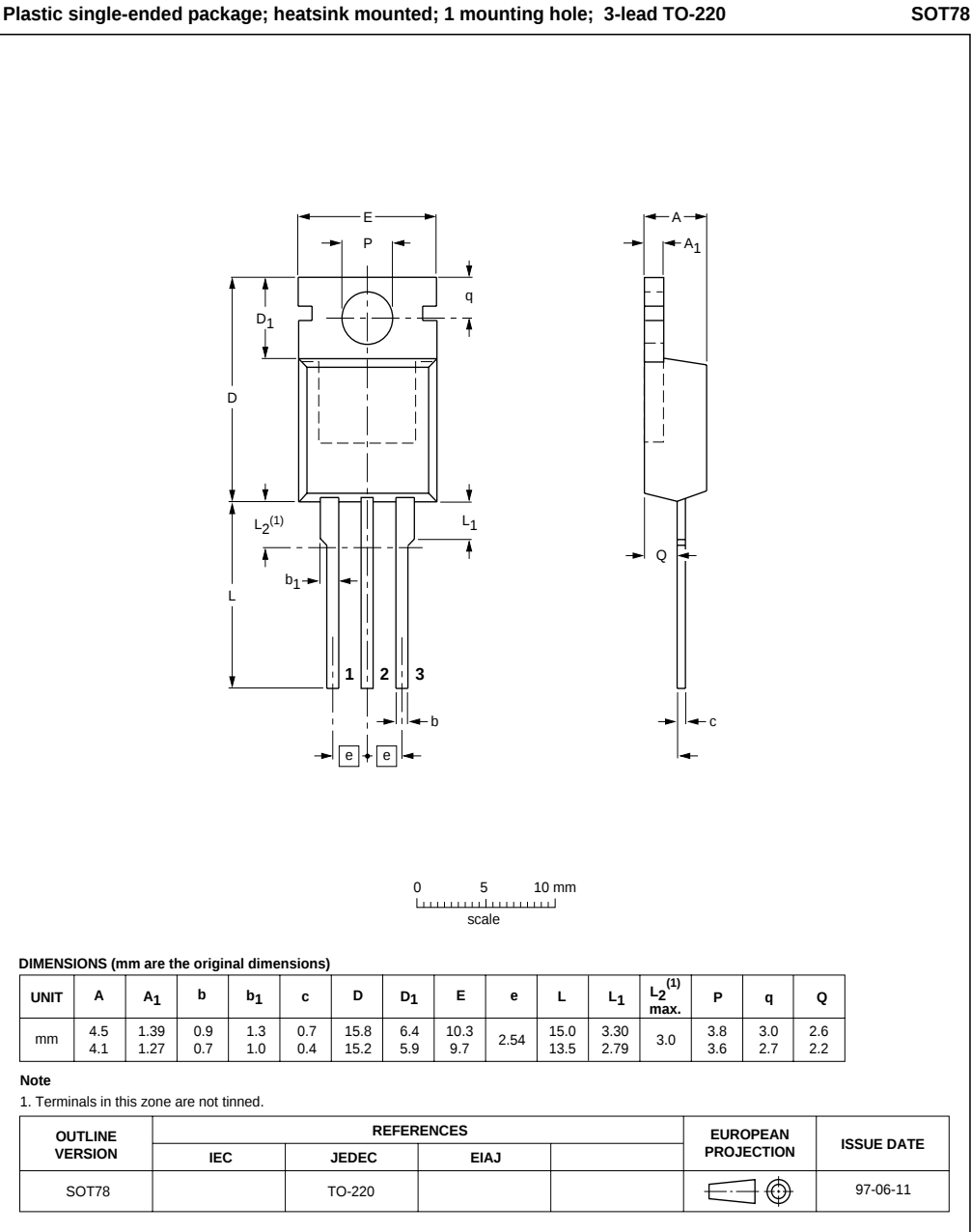


Fig.16. SOT78 (TO220AB); pin 2 connected to mounting base (Net mass:2g)

- Notes**
- 1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
 - 2. Refer to mounting instructions for SOT78 (TO220AB) package.
 - 3. Epoxy meets UL94 V0 at 1/8".

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N-channel logic level TrenchMOSTM transistor

PSMN005-55B;
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MECHANICAL DATA

Plastic single-ended surface mounted package (Philips version of D²-PAK); 3 leads
(one lead cropped)

SOT404

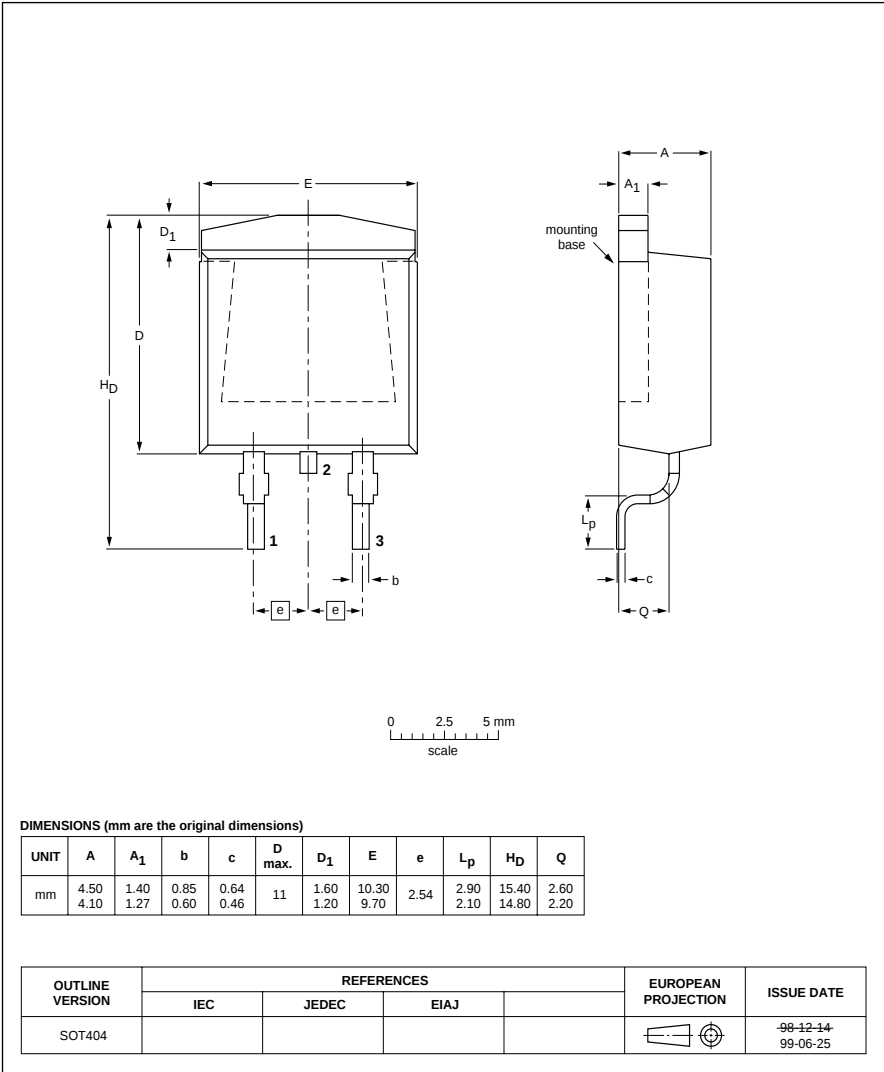


Fig.17. SOT404 surface mounting package. Centre pin connected to mounting base.

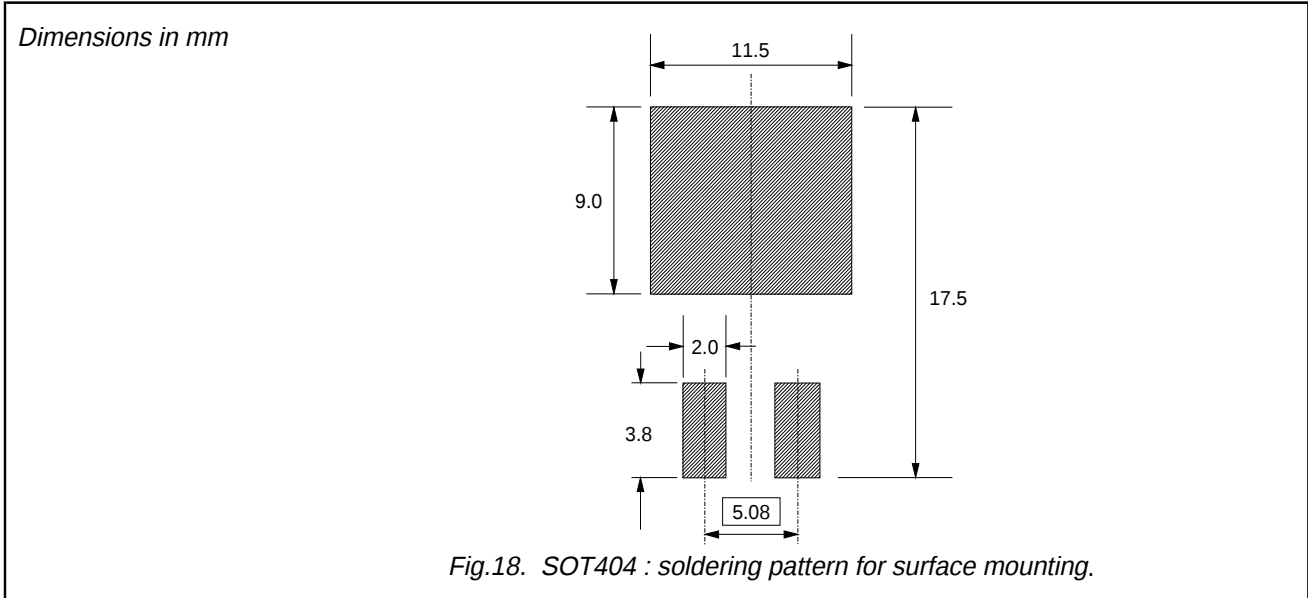
- Notes
- 1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
 - 2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
 - 3. Epoxy meets UL94 V0 at 1/8".

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N-channel logic level TrenchMOS^(TM) transistor

PSMN005-55B;
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MOUNTING INSTRUCTIONS



DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	
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PSMN005-55P**NOTES**

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